

**MAQ5 4 0**

item can replace **BFQ540**



Approved by:
Checked by:
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# **SPECIFICATION**

PRODUCT: NPN 9.0GHz wideband transistor

MODEL: MAQ540 S OT89

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**FEATURES**

- High gain
- High output voltage
- Low noise
- Gold metallization ensures excellent reliability
- Low thermal resistance.

**APPLICATIONS**

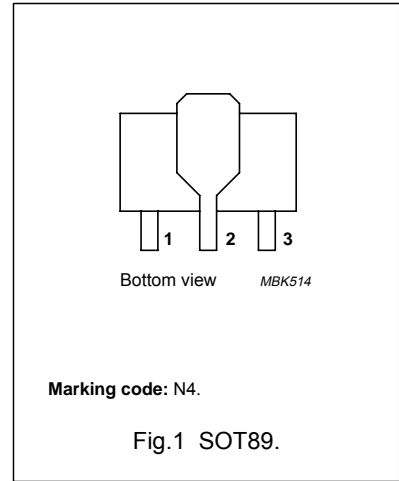
- VHF, UHF and CATV amplifiers.

**DESCRIPTION**

NPN wideband dual transistor in a plastic SOT89 package.

**PINNING**

PIN	DESCRIPTION
1	emitter
2	collector
3	base



**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	–	20	V
$V_{CES}$	collector-emitter voltage	$R_{BE} = 0$	–	–	15	V
$V_{EBO}$	collector-base voltage	open collector	–	–	2	V
$I_C$	collector current (DC)		–	–	120	mA
$P_{tot}$	total power dissipation	$T_s \leq 60\text{ }^\circ\text{C}$ ; note 1	–	–	1.2	W
$h_{FE}$	DC current gain	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $T_j = 25\text{ }^\circ\text{C}$	60	120	250	
$f_T$	transition frequency	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 1\text{ GHz}$ ; $T_{amb} = 25\text{ }^\circ\text{C}$	–	9	–	GHz
$ S_{21} ^2$	insertion power gain	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $T_{amb} = 25\text{ }^\circ\text{C}$	12	13	–	dB
F	noise figur	$I_C = 40\text{ mA}$ ; $V_{CE} = 8\text{ V}$ ; $f = 900\text{ MHz}$ ; $\Gamma_S = \Gamma_{opt}$	–	1.9	2.4	dB

**Note**

1.  $T_s$  is the temperature at the soldering point of the collector pin.

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	–	20	V
$V_{CES}$	collector-emitter voltage	$R_{BE} = 0$	–	15	V
$V_{EBO}$	emitter-base voltage	open collector	–	2	V
$I_C$	collector current (DC)		–	120	mA
$P_{tot}$	total power dissipation	$T_s \leq 60\text{ }^\circ\text{C}$	–	1.2	W
$T_{stg}$	storage temperature		–65	+150	$^\circ\text{C}$
$T_j$	operating junction temperature		–	175	$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-s}$	thermal resistance from junction to soldering point	$T_s \leq 60\text{ }^\circ\text{C}; P_{tot} = 1.2\text{ W}$	95	K/W

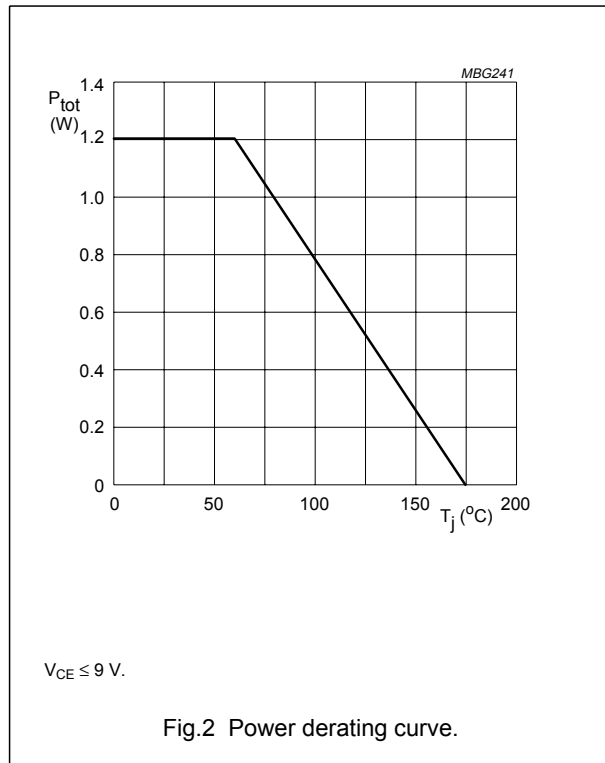


Fig.2 Power derating curve.

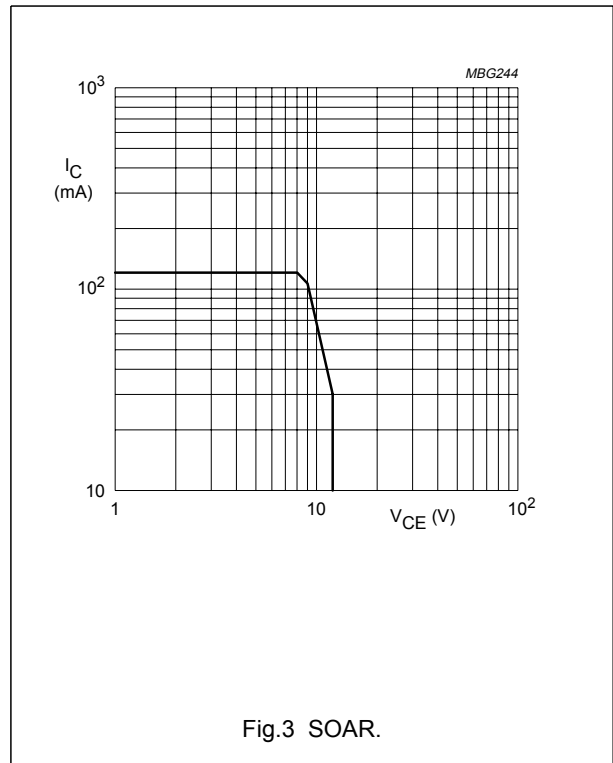


Fig.3 SOAR.

**CHARACTERISTICS**

T<sub>j</sub> = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>(BR)CBO</sub>	collector-base breakdown voltage	open emitter; I <sub>C</sub> = 10 μA; I <sub>E</sub> = 0	20	–	–	V
V <sub>(BR)CES</sub>	collector-emitter breakdown voltage	R <sub>BE</sub> = 0; I <sub>C</sub> = 40 μA	15	–	–	V
V <sub>(BR)EBO</sub>	emitter-base breakdown voltage	I <sub>E</sub> = 100 μA; I <sub>C</sub> = 0	2	–	–	V
I <sub>CBO</sub>	collector-base leakage current	V <sub>CB</sub> = 8 V; I <sub>E</sub> = 0	–	–	50	nA
I <sub>EBO</sub>	emitter-base leakage current	V <sub>CB</sub> = 1 V; I <sub>C</sub> = 0	–	–	200	nA
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 40 mA; V <sub>CE</sub> = 8 V	60	120	250	
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 40 mA; V <sub>CE</sub> = 8 V; f <sub>m</sub> = 1 GHz	–	9	–	GHz
C <sub>e</sub>	emitter capacitance	I <sub>C</sub> = i <sub>e</sub> = 0; V <sub>EB</sub> = 0.5 V; f = 1 MHz	–	2	–	pF
C <sub>re</sub>	feedback capacitance	I <sub>C</sub> = 0; V <sub>CE</sub> = 8 V; f = 1 MHz	–	0.9	–	pF
S <sub>21</sub>   <sup>2</sup>	insertion power gain	I <sub>C</sub> = 40 mA; V <sub>CE</sub> = 8 V; f = 900 MHz; T <sub>amb</sub> = 25 °C	12	13	–	dB
V <sub>o</sub>	output voltage	note 1	–	500	–	mV
		note 2	–	350	–	mV
d <sub>2</sub>	second order intermodulation distortion	note 3	–	–	–53	dB
F	noise figur	I <sub>C</sub> = 40 mA; V <sub>CE</sub> = 8 V; f = 900 MHz; Γ <sub>S</sub> = Γ <sub>opt</sub>	–	1.9	2.4	dB

**Notes**

- d<sub>im</sub> = –60 dB (DIN45004B); V<sub>CE</sub> = 8 V; I<sub>C</sub> = 40 mA; R<sub>L</sub> = 50 Ω;  
V<sub>p</sub> = V<sub>o</sub>; V<sub>q</sub> = V<sub>o</sub> –6 dB; V<sub>r</sub> = V<sub>o</sub> –6 dB;  
f<sub>p</sub> = 795.25 MHz; f<sub>q</sub> = 803.25 MHz; f<sub>r</sub> = 805.5 MHz;  
measured at f<sub>p</sub> + f<sub>q</sub> – f<sub>r</sub> = 793.25 MHz.
- d<sub>im</sub> = –60 dB (DIN 45004B); I<sub>C</sub> = 40 mA; V<sub>CE</sub> = 8 V; R<sub>L</sub> = 50 Ω;  
V<sub>p</sub> = V<sub>q</sub> = V<sub>o</sub>; f<sub>p</sub> = 806 MHz; f<sub>q</sub> = 810 MHz;  
measured at 2f<sub>p</sub> – f<sub>q</sub> = 802 MHz.
- I<sub>C</sub> = 40 mA; V<sub>CE</sub> = 8 V; R<sub>L</sub> = 50 Ω;  
V<sub>p</sub> = V<sub>q</sub> = 225 mV; f<sub>p</sub> = 250 MHz; f<sub>q</sub> = 560 MHz;  
measured at f<sub>p</sub> + f<sub>q</sub> = 810 MHz.

